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REFERENCE DESIGNATION		U.S. PATENT DOCUMENTS					
Examiner Initial		Document Number	Date	Name	Class	Sub-Class	Filing Date if Approp.
<i>JQ</i>	AA	2001/0024701	9/27/01	Matsukura et al	428	14	3/13/01
<i>JL</i>	AB	2002/0127477	9/12/02	Levinson et al	430	5	1/26/01
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<i>JQ</i>	AJ	8-160597	6/21/96	Japan	G03F	1/08	X
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<i>JQ</i>	AL	Julian Blake; "Simox (Separation by Implantation of Oxygen); Encyclopedia of Physical Science and Technology; Third Edition; Volume 14; July 2001; pages 805-813
<i>JQ</i>	AM	Bruel et al; "Smart Cut: A Promising New SOI Material Technology"; IEEE International SOI Conference; Oct. 1995; pages 178-179.
<i>JQ</i>	AN	Maleville et al.; "Multiple SOI Layers by Multiple Smart-Cut Transfers"; IEEE International SOI Conference; Oct. 2000; pages 134-135.
<i>JQ</i>	AO	Moriceau et al.; "Cleaning and Polishing as Key Steps for Smart-Cut SOI Process"; IEEE International SOI Conference; Oct. 1996, pages 152-153.
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EXAMINER:

DATE CONSIDERED:

2/06

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609: draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.